## : ©hipsmall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts,Customers Priority,Honest Operation, and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!


## Contact us

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Email \& Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, \#122 Zhenhua RD., Futian, Shenzhen, China


## Materials

1. Shell, brass, nickel plated
2. Terminal, phosphor bronze, $5 \mu$ " gold and tin plating
3. Terminal, brass, $5 \mu$ " gold and tin plating
4. Insulator, PBT, blue

## Electrical

Rated voltage: 30 Vdc
Rated current: 3 A
Dielectric strength: 1 min @ 500 Vac
Insulation resistance: $500 \mathrm{M} \Omega$ @ 500 Vdc
Contact resistance: $50 \mathrm{~m} \Omega$ or less

## Mechanical

Insertion force: 3.5 kgf maximum
Withdrawal force: 1.0 kgf minimum
Durability: 1500 cycle minimum life; less than $100 \mathrm{~m} \Omega$ contact resistance, minimum $100 \mathrm{M} \Omega$ insulation resistance
Terminal strength: 0.3 kgf in any direction for 15 seconds without damage or looseness

## Soldering

Solderability: $75 \%$ minimum coverage when terminals dipped 2 mm in $245 \pm 5^{\circ} \mathrm{C}$ solder bath for $3 \pm 0.5$ seconds
Solder bath durability: no deformation when immersed in $255 \pm 5^{\circ} \mathrm{C}$ up to surface of the board for 5 seconds or less
Solder iron durability: no deformation when exposed to $350 \pm 10^{\circ} \mathrm{C}$ for $3 \pm 0.5$ seconds

## Environmental

Cold test: $-40 \pm 3^{\circ} \mathrm{C}$ for 48 hours without deformation Heat test: $85 \pm 2{ }^{\circ} \mathrm{C}$ for 48 hours without deformation Humidity test: $40 \pm 2^{\circ} \mathrm{C}$ and humidity between 90 and $98 \%$ for 48 hours without deformation

## Operating range <br> $-40 \sim 85^{\circ} \mathrm{C}$

USB A 3.0 jack $180^{\circ}$ PCB mount


PCB Layout

| REVISION | DATE | DESCRIPTION | PREPARED: | NOTES <br> RoHS and REACH compliant | TENSILITY <br> 20802 Sockeye Place \#130 <br> Bend, OR 97701 USA <br> tel 541.323.3228 fax 541.323.4202 <br> 800 877.670.7118 www.tensility.com |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| A | 9/28/2015 | Initial release | $\text { JM } \quad \begin{gathered} 2015.10 .09 \\ 12: 07: 20-00^{\prime} 00 \\ \hline \end{gathered}$ |  |  |  |  |
|  |  |  | VERIFIED: <br> GL |  |  |  |  |
|  |  |  | DIMENSIONS ARE IN MILLIMETERS |  |  |  |  |
|  |  |  | TOLERANCES: <br> Up to 1.0: $\pm 0.1 \mathrm{~mm}$ <br> 1.0 to 10.0: $\pm 0.2 \mathrm{~mm}$ <br> Over 10.0: $\pm 0.3 \mathrm{~mm}$ | DESCRIPTION: <br> Connector, USB A 3.0 Jack, PCB mount, $180^{\circ}$, nickel shell, DIP, board lock, blue insulator | $\begin{array}{\|c\|} \hline \text { SIZE } \\ \text { A } \end{array}$ |  |  |
|  |  |  |  |  | SCAL | 1:1 | SHEET 2 OF 2 |

